## Si4058DY

RoHS

COMPLIANT

HALOGEN

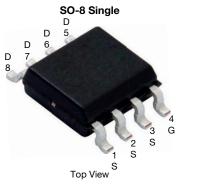
FREE



Vishay Siliconix

## N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (TYP.)			
100	0.026 at V <sub>GS</sub> = 10 V	10.3	5.8 nC			
100	0.033 at V <sub>GS</sub> = 4.5 V	9.2	5.6110			

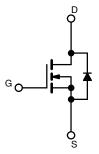


#### **FEATURES**

- ThunderFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- DC/DC primary side switch
- Synchronous rectification
- Fast charger
- Industrial



N-Channel MOSFET

**Ordering Information:** 

Si4058DY-T1-GE3 (lead (Pb)-free and halogen-free)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	100	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		10.3		
Continuous Drain Current (T. 150 °C)	T <sub>C</sub> = 70 °C	1 , Г	8.3		
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	T <sub>A</sub> = 25 °C	- I <sub>D</sub> -	7 b, c		
	T <sub>A</sub> = 70 °C		5.5 <sup>b, c</sup>	А	
Pulsed Drain Current (t = 300 µs)		I <sub>DM</sub>	50		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	5		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	15		
Avalanche Energy		E <sub>AS</sub>	11.2	mJ	
	T <sub>C</sub> = 25 °C		5.6		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		3.6	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.6 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C	1 –	1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperatur	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	48	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	18	22	C/W		

#### Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ .

b. Surface mounted on 1" x 1" FR4 board

d. Maximum under steady state conditions is 90 °C/W.

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c. t = 10 s.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		•	•		•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J J J 050.04		61	-	mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-3.8	-	mv/ C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2	-	2.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	-	-	10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V},  V_{GS} = 10 \text{ V}$	20	-	-	А	
Ducia Course On Chota Desistance à	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	- 0.0217 0.0260		0.0260		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	0.0266	0.0330	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	31	-	S	
Dynamic <sup>b</sup>		•		·			
Input Capacitance	Ciss		-	690	-	pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	280	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	11	-		
Total Gate Charge	Qg	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	12	18	nC	
			-	5.8	9		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2.1	-		
Gate-Drain Charge	Q <sub>gd</sub>		-	2.2	-		
Output Charge	Q <sub>oss</sub>	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	22.5	35		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.8	2.2	4.0	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>		-	8	16		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 V, R_1 = 5 \Omega$	-	17	34	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	11	22		
Fall Time	t <sub>f</sub>		-	8	16		
Turn-On Delay Time	t <sub>d(on)</sub>		-	7	14	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 5 \Omega$	-	16	32	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$	-	12	24		
Fall Time	t <sub>f</sub>	1	-	7	14		
Drain-Source Body Diode Characteristi	cs	·					
Continuous Source-Drain Diode Current	IS	T <sub>C</sub> = 25 °C	-	-	5		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		-	-	50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.81	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>		-	56	112	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs,	-	60	120	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$T_J = 25 \ ^\circ C$	-	48	-		
Reverse Recovery Rise Time	t <sub>b</sub>			8	_	ns	

#### Notes

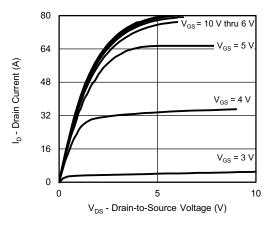
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

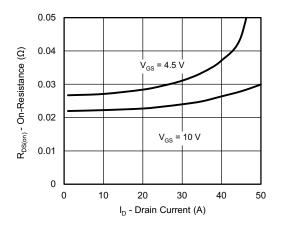
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



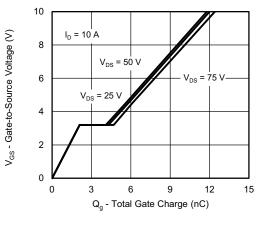
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



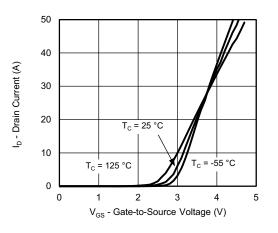
**Output Characteristics** 



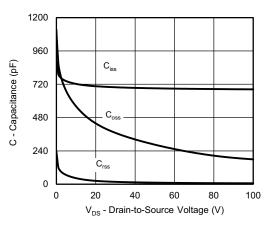
**On-Resistance vs. Drain Current** 



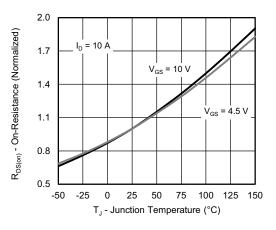
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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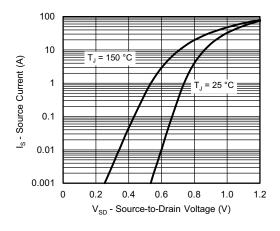
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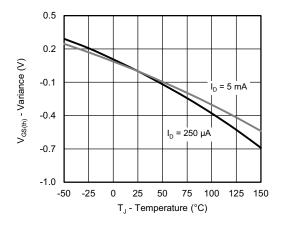
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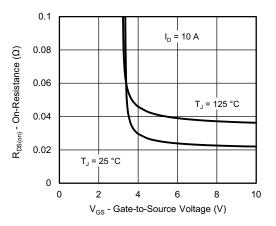
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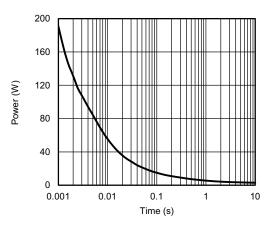
Source-Drain Diode Forward Voltage



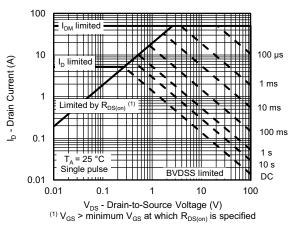
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

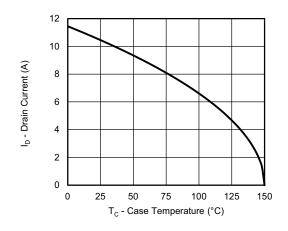
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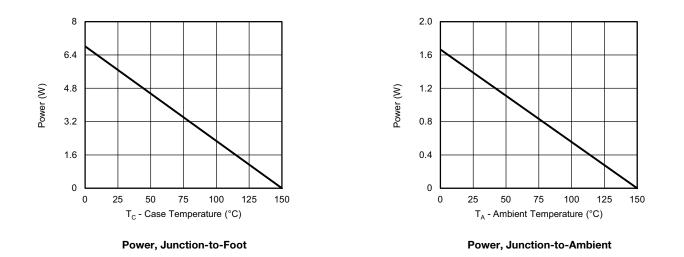
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating <sup>a</sup>

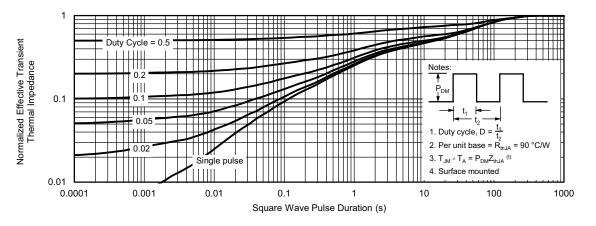


#### Note

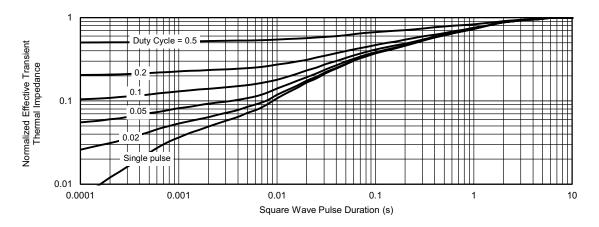
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67409.



# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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